Infineon Technologies - MB90598GPF-G-173-JNE1 Datasheet

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	F²MC-16LX
Core Size	16-Bit
Speed	16MHz
Connectivity	CANbus, EBI/EMI, SCI, Serial I/O, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	78
Program Memory Size	128KB (128K x 8)
Program Memory Type	Mask ROM
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-QFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90598gpf-g-173-jne1

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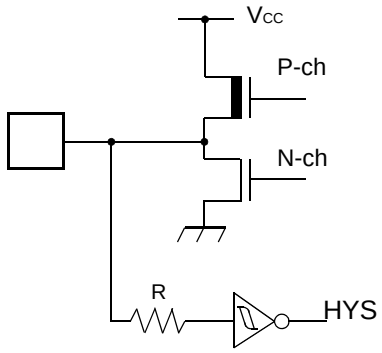
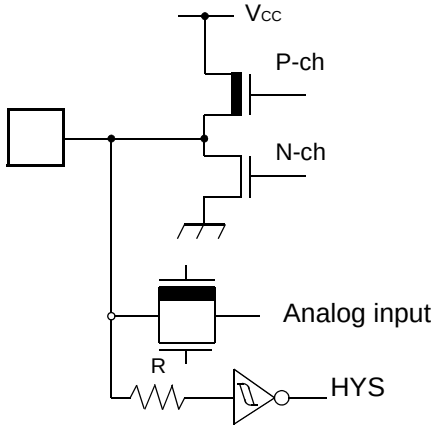
1. Product Lineup

Features		MB90598G	MB90F598G	MB90V595G
Classification		Mask ROM product	Flash ROM product	Evaluation product
ROM size		128 Kbytes	128 Kbytes Boot block Hard-wired reset vector	None
RAM size		4 Kbytes	4 Kbytes	6 Kbytes
Emulator-specific power supply *1		—		None
CPU functions		The number of instructions: 351 Instruction bit length: 8 bits, 16 bits Instruction length: 1 byte to 7 bytes Data bit length: 1 bit, 8 bits, 16 bits Minimum execution time: 62.5 ns (at machine clock frequency of 16 MHz) Interrupt processing time: 1.5 μs (at machine clock frequency of 16 MHz, minimum value)		
UART0		Clock synchronized transmission (500 K/1 M/2 Mbps) Clock asynchronized transmission (4808/5208/9615/10417/19230/38460/62500 /500000 bps at machine clock frequency of 16 MHz) Transmission can be performed by bi-directional serial transmission or by master/slave connection.		
UART1(SCI)		Clock synchronized transmission (62.5 K/125 K/250 K/500 K/1 Mbps) Clock asynchronized transmission (1202/2404/4808/9615/31250 bps) Transmission can be performed by bi-directional serial transmission or by master/slave connection.		
8/10-bit A/D converter		Conversion precision: 8/10-bit can be selectively used. Number of inputs: 8 One-shot conversion mode (converts selected channel once only) Scan conversion mode (converts two or more successive channels and can program up to 8 channels) Continuous conversion mode (converts selected channel continuously) Stop conversion mode (converts selected channel and stop operation repeatedly)		
8/16-bit PPG timers (6 channels)		Number of channels: 6 (8/16-bit × 6 channels) PPG operation of 8-bit or 16-bit A pulse wave of given intervals and given duty ratios can be output. Pulse interval: fsys, fsys/2^1, fsys/2^2, fsys/2^3, fsys/2^4 (fsys = system clock frequency) 128μs (fosc = 4MHz: oscillation clock frequency)		
16-bit Reload timer		Number of channels: 2 Operation clock frequency: fsys/2^1, fsys/2^3, fsys/2^5 (fsys = System clock frequency) Supports External Event Count function		
16-bit I/O timer	16-bit Output compares	Number of channels: 4 Pin input factor: A match signal of compare register		
	Input captures	Number of channels: 4 Rewriting a register value upon a pin input (rising, falling, or both edges)		

Circuit Type	Circuit	Remarks
D		■ CMOS output ■ CMOS Hysteresis input
E		■ CMOS output ■ CMOS Hysteresis input ■ Analog input

(Continued)

5. Handling Devices

(1) Make Sure that the Voltage not Exceed the Maximum Rating (to Avoid a Latch-up).

In CMOS ICs, a latch-up phenomenon is caused when an voltage exceeding V_{CC} or an voltage below V_{SS} is applied to input or output pins or a voltage exceeding the rating is applied across V_{CC} and V_{SS}.

When a latch-up is caused, the power supply current may be dramatically increased causing resultant thermal break-down of devices. To avoid the latch-up, make sure that the voltage not exceed the maximum rating.

In turning on/turning off the analog power supply, make sure the analog power voltage (AV_{CC}, AVRH, DV_{CC}) and analog input voltages not exceed the digital voltage (V_{CC}).

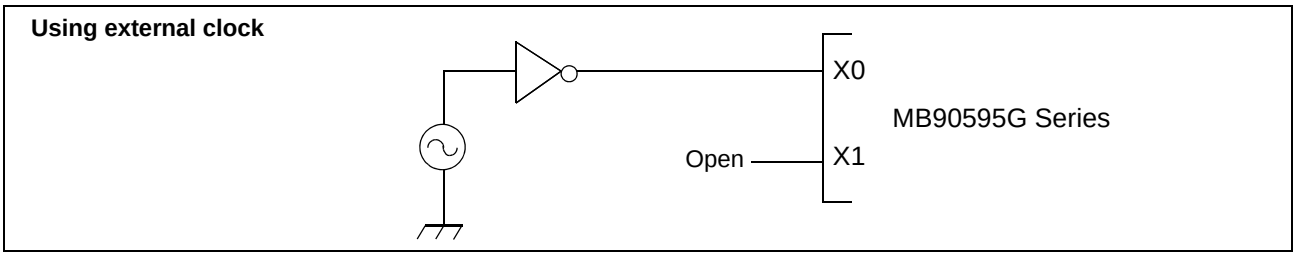
(2) Treatment of Unused Pins

Unused input pins left open may cause abnormal operation, or latch-up leading to permanent damage. Unused input pins should be pulled up or pulled down through at least 2 kΩ resistance.

Unused input/output pins may be left open in output state, but if such pins are in input state they should be handled in the same way as input pins.

(3) Using external clock

In using the external clock, drive X0 pin only and leave X1 pin unconnected.

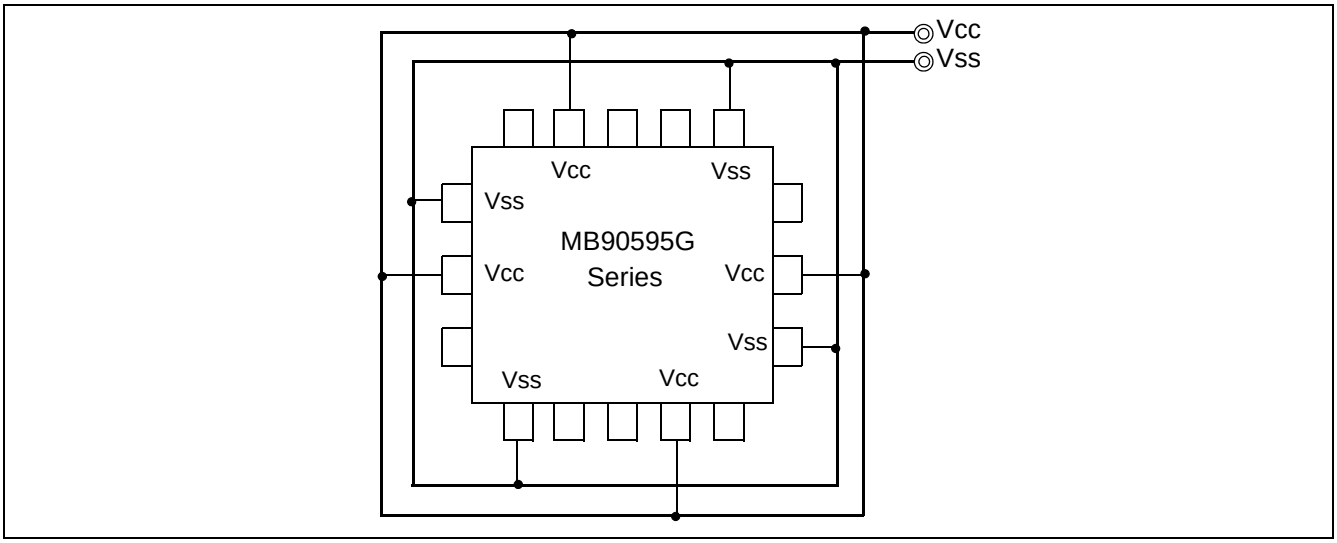


(4) Power supply pins (Vcc/Vss)

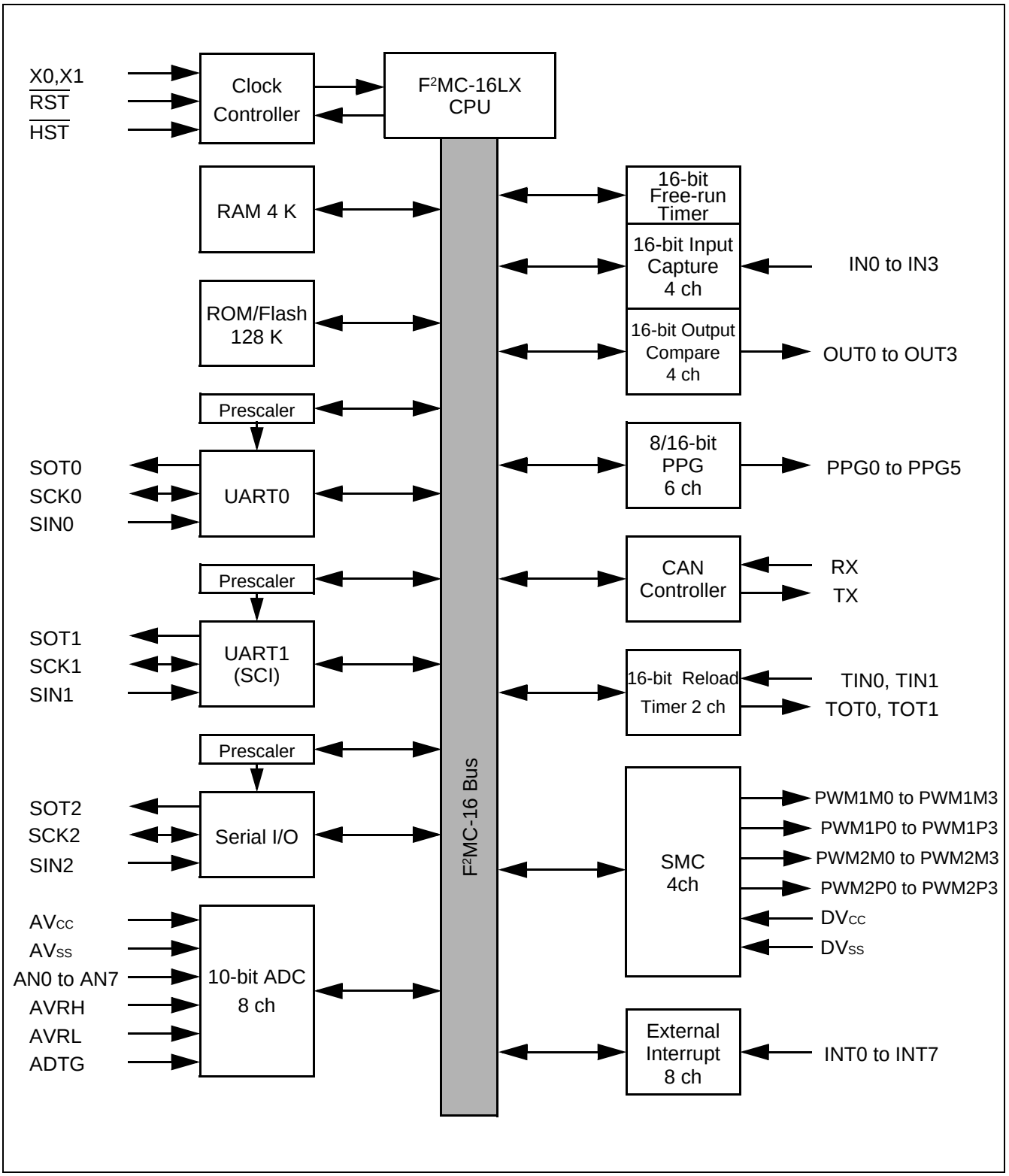
In products with multiple V_{cc} or V_{ss} pins, pins with the same potential are internally connected in the device to avoid abnormal operations including latch-up. However, you must connect the pins to an external power and a ground line to lower the electro-magnetic emission level, to prevent abnormal operation of strobe signals caused by the rise in the ground level, and to conform to the total current rating (See the figure below.)

Make sure to connect V_{cc} and V_{ss} pins via lowest impedance to power lines.

It is recommended to provide a bypass capacitor of around 0.1 μF between V_{cc} and V_{ss} pins near the device.



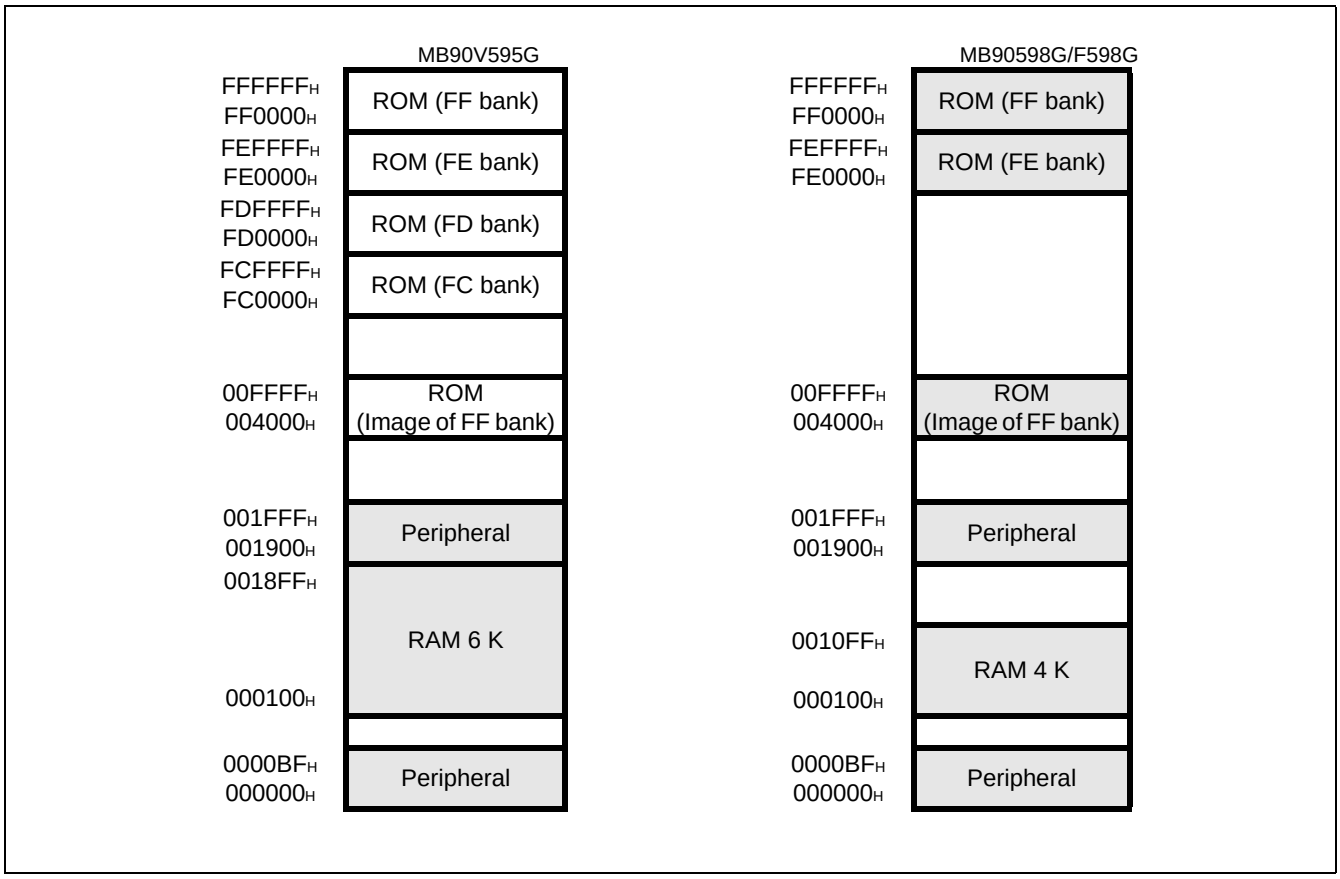
6. Block Diagram



7. Memory Space

The memory space of the MB90595G Series is shown below

Figure 1. Memory space map



Note: : The ROM data of bank FF is reflected in the upper address of bank 00, realizing effective use of the C compiler small model. The lower 16-bit of bank FF and the lower 16-bit of bank 00 are assigned to the same address, enabling reference of the table on the ROM without stating “far”.
For example, if an attempt has been made to access 00C000H , the contents of the ROM at FFC000H are accessed. Since the ROM area of the FF bank exceeds 48 Kbytes, the whole area cannot be reflected in the image for the 00 bank. The ROM data at FF4000H to FFFFFFH looks, therefore, as if it were the image for 004000H to 00FFFFH. Thus, it is recommended that the ROM data table be stored in the area of FF4000H to FFFFFFH.

8. I/O Map

Address	Register	Abbreviation	Access	Peripheral	Initial value
00_H	Port 0 Data Register	PDR0	R/W	Port 0	$XXXXXXXX_B$
01_H	Port 1 Data Register	PDR1	R/W	Port 1	$XXXXXXXX_B$
02_H	Port 2 Data Register	PDR2	R/W	Port 2	$XXXXXXXX_B$
03_H	Port 3 Data Register	PDR3	R/W	Port 3	$XXXXXXXX_B$
04_H	Port 4 Data Register	PDR4	R/W	Port 4	$XXXXXXXX_B$
05_H	Port 5 Data Register	PDR5	R/W	Port 5	$XXXXXXXX_B$
06_H	Port 6 Data Register	PDR6	R/W	Port 6	$XXXXXXXX_B$
07_H	Port 7 Data Register	PDR7	R/W	Port 7	$XXXXXXXX_B$
08_H	Port 8 Data Register	PDR8	R/W	Port 8	$XXXXXXXX_B$
09_H	Port 9 Data Register	PDR9	R/W	Port 9	$\_\_XXXXXX_B$
$0A_H$ to $0F_H$	Reserved				
10_H	Port 0 Direction Register	DDR0	R/W	Port 0	00000000_B
11_H	Port 1 Direction Register	DDR1	R/W	Port 1	00000000_B
12_H	Port 2 Direction Register	DDR2	R/W	Port 2	00000000_B
13_H	Port 3 Direction Register	DDR3	R/W	Port 3	00000000_B
14_H	Port 4 Direction Register	DDR4	R/W	Port 4	00000000_B
15_H	Port 5 Direction Register	DDR5	R/W	Port 5	00000000_B
16_H	Port 6 Direction Register	DDR6	R/W	Port 6	00000000_B
17_H	Port 7 Direction Register	DDR7	R/W	Port 7	00000000_B
18_H	Port 8 Direction Register	DDR8	R/W	Port 8	00000000_B
19_H	Port 9 Direction Register	DDR9	R/W	Port 9	$\_\_000000_B$
$1A_H$	Reserved				
$1B_H$	Analog Input Enable Register	ADER	R/W	Port 6, A/D	11111111_B
$1C_H$ to $1F_H$	Reserved				
20_H	Serial Mode Control Register 0	UMC0	R/W	UART0	00000100_B
21_H	Serial status Register 0	USR0	R/W		00010000_B
22_H	Serial Input/Output Data Register 0	UIDR0/UODR0	R/W		$XXXXXXXX_B$
23_H	Rate and Data Register 0	URD0	R/W		$0000000X_B$
24_H	Serial Mode Register 1	SMR1	R/W	UART1	00000000_B
25_H	Serial Control Register 1	SCR1	R/W		00000100_B
26_H	Serial Input/Output Data Register 1	SIDR1/SODR1	R/W		$XXXXXXXX_B$
27_H	Serial Status Register 1	SSR1	R/W		0001_00_B
28_H	UART1 Prescaler Control Register	U1CDCR	R/W		$0\_\_\_1111_B$

(Continued)

Address	Register	Abbreviation	Access	Peripheral	Initial value
29H to 2AH	Reserved				
2BH	Serial IO Prescaler	SCDCR	R/W	Serial IO	0 _ _ _ 1 1 1 1B
2CH	Serial Mode Control Register (low-order)	SMCS	R/W		_ _ _ _ 0 0 0 0B
2DH	Serial Mode Control Register (high-order)	SMCS	R/W		0 0 0 0 0 0 1 0B
2EH	Serial Data Register	SDR	R/W		XXXXXXXXB
2FH	Edge Selector	SES	R/W		_ _ _ _ _ _ _ 0B
30H	External Interrupt Enable Register	ENIR	R/W	External Interrupt	0 0 0 0 0 0 0 0B
31H	External Interrupt Request Register	EIRR	R/W		XXXXXXXXB
32H	External Interrupt Level Register	ELVR	R/W		0 0 0 0 0 0 0 0B
33H	External Interrupt Level Register	ELVR	R/W		0 0 0 0 0 0 0 0B
34H	A/D Control Status Register 0	ADCS0	R/W	A/D Converter	0 0 0 0 0 0 0 0B
35H	A/D Control Status Register 1	ADCS1	R/W		0 0 0 0 0 0 0 0B
36H	A/D Data Register 0	ADCR0	R		XXXXXXXXB
37H	A/D Data Register 1	ADCR1	R/W		0 0 0 0 1 _ XXB
38H	PPG0 Operation Mode Control Register	PPGC0	R/W	16-bit Programmable Pulse Generator 0/1	0 _ 0 0 0 _ _ 1B
39H	PPG1 Operation Mode Control Register	PPGC1	R/W		0 _ 0 0 0 0 0 1B
3AH	PPG0, 1 Output Pin Control Register	PPG01	R/W		0 0 0 0 0 0 _ _B
3BH	Reserved				
3CH	PPG2 Operation Mode Control Register	PPGC2	R/W	16-bit Programmable Pulse Generator 2/3	0 _ 0 0 0 _ _ 1B
3DH	PPG3 Operation Mode Control Register	PPGC3	R/W		0 _ 0 0 0 0 0 1B
3EH	PPG2, 3 Output Pin Control Register	PPG23	R/W		0 0 0 0 0 0 _ _B
3FH	Reserved				
40H	PPG4 Operation Mode Control Register	PPGC4	R/W	16-bit Programmable Pulse Generator 4/5	0 _ 0 0 0 _ _ 1B
41H	PPG5 Operation Mode Control Register	PPGC5	R/W		0 _ 0 0 0 0 0 1B
42H	PPG4, 5 Output Pin Control Register	PPG45	R/W		0 0 0 0 0 0 _ _B
43H	Reserved				
44H	PPG6 Operation Mode Control Register	PPGC6	R/W	16-bit Programmable Pulse Generator 6/7	0 _ 0 0 0 _ _ 1B
45H	PPG7 Operation Mode Control Register	PPGC7	R/W		0 _ 0 0 0 0 0 1B
46H	PPG6, 7 Output Pin Control Register	PPG67	R/W		0 0 0 0 0 0 _ _B
47H	Reserved				
48H	PPG8 Operation Mode Control Register	PPGC8	R/W	16-bit Programmable Pulse Generator 8/9	0 _ 0 0 0 _ _ 1B
49H	PPG9 Operation Mode Control Register	PPGC9	R/W		0 _ 0 0 0 0 0 1B
4AH	PPG8, 9 Output Pin Control Register	PPG89	R/W		0 0 0 0 0 0 _ _B
4BH	Reserved				

(Continued)

Address	Register	Abbreviation	Access	Peripheral	Initial value
1910H	Reload Register L	PRLL8	R/W	16-bit Programmable Pulse Generator 8/9	XXXXXXXXB
1911H	Reload Register H	PRLH8	R/W		XXXXXXXXB
1912H	Reload Register L	PRLL9	R/W		XXXXXXXXB
1913H	Reload Register H	PRLH9	R/W		XXXXXXXXB
1914H	Reload Register L	PRLLA	R/W	16-bit Programmable Pulse Generator A/B	XXXXXXXXB
1915H	Reload Register H	PRLHA	R/W		XXXXXXXXB
1916H	Reload Register L	PRLLB	R/W	16-bit Programmable Pulse Generator A/B	XXXXXXXXB
1917H	Reload Register H	PRLHB	R/W		XXXXXXXXB
1918H to 191FH	Reserved				
1920H	Input Capture Register 0 (low-order)	IPCP0	R	Input Capture 0/1	XXXXXXXXB
1921H	Input Capture Register 0 (high-order)	IPCP0	R		XXXXXXXXB
1922H	Input Capture Register 1 (low-order)	IPCP1	R		XXXXXXXXB
1923H	Input Capture Register 1 (high-order)	IPCP1	R		XXXXXXXXB
1924H	Input Capture Register 2 (low-order)	IPCP2	R	Input Capture 2/3	XXXXXXXXB
1925H	Input Capture Register 2 (high-order)	IPCP2	R		XXXXXXXXB
1926H	Input Capture Register 3 (low-order)	IPCP3	R		XXXXXXXXB
1927H	Input Capture Register 3 (high-order)	IPCP3	R		XXXXXXXXB
1928H	Output Compare Register 0 (low-order)	OCCP0	R/W	Output Compare 0/1	XXXXXXXXB
1929H	Output Compare Register 0 (high-order)	OCCP0	R/W		XXXXXXXXB
192AH	Output Compare Register 1 (low-order)	OCCP1	R/W		XXXXXXXXB
192BH	Output Compare Register 1 (high-order)	OCCP1	R/W		XXXXXXXXB

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Address	Register	Abbreviation	Access	Initial Value
001B08H	IDE register	IDER	R/W	XXXXXXXX XXXXXXXXB
001B09H				
001B0AH	Transmit RTR register	TRTRR	R/W	00000000 00000000B
001B0BH				
001B0CH	Remote frame receive waiting register	RFWTR	R/W	XXXXXXXX XXXXXXXXB
001B0DH				
001B0EH	Transmit interrupt enable register	TIER	R/W	00000000 00000000B
001B0FH				
001B10H	Acceptance mask select register	AMSR	R/W	XXXXXXXX XXXXXXXXB
001B11H				
001B12H				XXXXXXXX XXXXXXXXB
001B13H				
001B14H	Acceptance mask register 0	AMR0	R/W	XXXXXXXX XXXXXXXXB
001B15H				
001B16H				XXXXX--- XXXXXXXXB
001B17H				
001B18H	Acceptance mask register 1	AMR1	R/W	XXXXXXXX XXXXXXXXB
001B19H				
001B1AH				XXXXX--- XXXXXXXXB
001B1BH				

9.2 List of Message Buffers (ID Registers)

Address	Register	Abbreviation	Access	Initial Value
001A00H to 001A1FH	General-purpose RAM	--	R/W	XXXXXXXXB to XXXXXXXXB
001A20H	ID register 0	IDR0	R/W	XXXXXXXX XXXXXXXXB
001A21H				
001A22H				XXXXX--- XXXXXXXXB
001A23H				
001A24H	ID register 1	IDR1	R/W	XXXXXXXX XXXXXXXXB
001A25H				
001A26H				XXXXX--- XXXXXXXXB
001A27H				
001A28H	ID register 2	IDR2	R/W	XXXXXXXX XXXXXXXXB
001A29H				
001A2AH				XXXXX--- XXXXXXXXB
001A2BH				

10. Interrupt Source, Interrupt Vector, and Interrupt Control Register

Interrupt source	EI²OS clear	Interrupt vector		Interrupt control register	
		Number	Address	Number	Address
Reset	N/A	# 08	FFFFDC$_H$	——	——
INT9 instruction	N/A	# 09	FFFFD8$_H$	——	——
Exception	N/A	# 10	FFFFD4$_H$	——	——
CAN RX	N/A	# 11	FFFFD0$_H$	ICR00	0000B0$_H$
CAN TX/NS	N/A	# 12	FFFFCC$_H$		
External Interrupt (INT0/INT1)	*1	# 13	FFFFC8$_H$	ICR01	0000B1$_H$
Time Base Timer	N/A	# 14	FFFFC4$_H$		
16-bit Reload Timer 0	*1	# 15	FFFFC0$_H$	ICR02	0000B2$_H$
8/10-bit A/D Converter	*1	# 16	FFFFBC$_H$		
16-bit Free-run Timer	N/A	# 17	FFFFB8$_H$	ICR03	0000B3$_H$
External Interrupt (INT2/INT3)	*1	# 18	FFFFB4$_H$		
Serial I/O	*1	# 19	FFFFB0$_H$	ICR04	0000B4$_H$
External Interrupt (INT4/INT5)	*1	# 20	FFFFAC$_H$		
Input Capture 0	*1	# 21	FFFFA8$_H$	ICR05	0000B5$_H$
8/16-bit PPG 0/1	N/A	# 22	FFFFA4$_H$		
Output Compare 0	*1	# 23	FFFFA0$_H$	ICR06	0000B6$_H$
8/16-bit PPG 2/3	N/A	# 24	FFFF9C$_H$		
External Interrupt (INT6/INT7)	*1	# 25	FFFF98$_H$	ICR07	0000B7$_H$
Input Capture 1	*1	# 26	FFFF94$_H$		
8/16-bit PPG 4/5	N/A	# 27	FFFF90$_H$	ICR08	0000B8$_H$
Output Compare 1	*1	# 28	FFFF8C$_H$		
8/16-bit PPG 6/7	N/A	# 29	FFFF88$_H$	ICR09	0000B9$_H$
Input Capture 2	*1	# 30	FFFF84$_H$		
8/16-bit PPG 8/9	N/A	# 31	FFFF80$_H$	ICR10	0000BA$_H$
Output Compare 2	*1	# 32	FFFF7C$_H$		
Input Capture 3	*1	# 33	FFFF78$_H$	ICR11	0000BB$_H$
8/16-bit PPG A/B	N/A	# 34	FFFF74$_H$		
Output Compare 3	*1	# 35	FFFF70$_H$	ICR12	0000BC$_H$
16-bit Reload Timer 1	*1	# 36	FFFF6C$_H$		
UART 0 RX	*2	# 37	FFFF68$_H$	ICR13	0000BD$_H$
UART 0 TX	*1	# 38	FFFF64$_H$		
UART 1 RX	*2	# 39	FFFF60$_H$	ICR14	0000BE$_H$
UART 1 TX	*1	# 40	FFFF5C$_H$		
Flash Memory	N/A	# 41	FFFF58$_H$	ICR15	0000BF$_H$
Delayed interrupt	N/A	# 42	FFFF54$_H$		

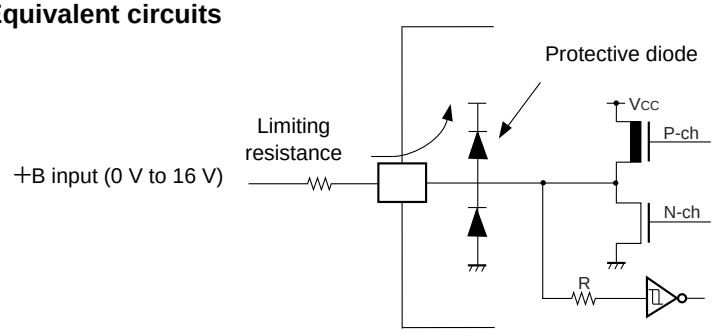
*1: The interrupt request flag is cleared by the EI²OS interrupt clear signal.

*2: The interrupt request flag is cleared by the EI²OS interrupt clear signal. A stop request is available.

N/A:The interrupt request flag is not cleared by the EI²OS interrupt clear signal.

- The value of the limiting resistance should be set so that when the +B signal is applied the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
- Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the V_{CC} pin, and this may affect other devices.
- Note that if a +B signal is input when the microcontroller current is off (not fixed at 0 V) , the power supply is provided from the pins, so that incomplete operation may result.
- Note that if the +B input is applied during power-on, the power supply is provided from the pins and the resulting supply voltage may not be sufficient to operate the power-on result.
- Care must be taken not to leave the +B input pin open.
- Note that analog system input/output pins other than the A/D input pins (LCD drive pins, comparator input pins, etc.) cannot accept +B signal input.
- Sample recommended circuits :

• Input/Output Equivalent circuits



Note: : Average output current = operating current × operating efficiency

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

11.2 Recommended Conditions

(V_{SS} = AV_{SS} = 0.0 V)

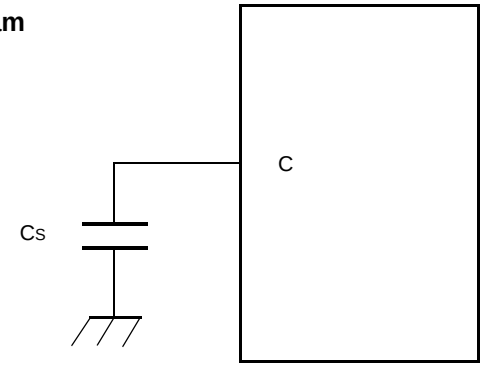
Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Power supply voltage	V_{CC} AV_{CC}	4.5	5.0	5.5	V	Under normal operation
		3.0	—	5.5	V	Maintains RAM data in stop mode
Smooth capacitor	C_S	0.022	0.1	1.0	µF	*
Operating temperature	T_A	–40	—	+85	°C	

*: Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. The smoothing capacitor to be connected to the V_{CC} pin must have a capacitance value higher than C_S.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

- **C Pin Connection Diagram**

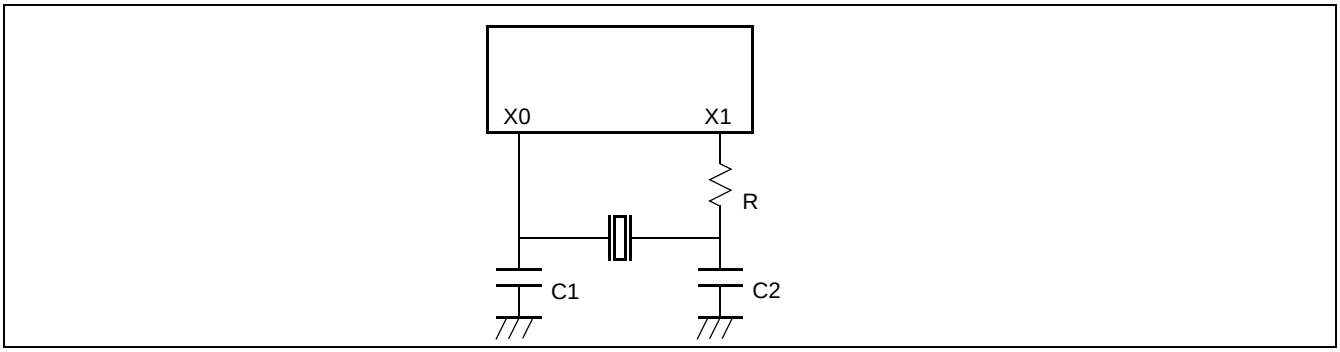


11.3 DC Characteristics

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Input H voltage	V_{IHS}	CMOS hysteresis input pin	—	0.8 V_{CC}	—	V_{CC} +0.3	V	
	V_{IHM}	MD input pin	—	V_{CC} – 0.3	—	V_{CC} +0.3	V	
Input L voltage	V_{ILS}	CMOS hysteresis input pin	—	V_{SS} – 0.3	—	0.2 V_{CC}	V	
	V_{ILM}	MD input pin	—	V_{SS} – 0.3	—	V_{SS} +0.3	V	
Output H voltage	V_{OH1}	Output pins except P70 to P87	V_{CC} = 4.5 V, I_{OH1} = –4.0 mA	V_{CC} – 0.5	—	—	V	
	V_{OH2}	P70 to P87	V_{CC} = 4.5 V, I_{OH2} = –30.0 mA	V_{CC} – 0.5	—	—	V	
Output L voltage	V_{OL1}	Output pins except P70 to P87	V_{CC} = 4.5 V, I_{OL1} = 4.0 mA	—	—	0.4	V	
	V_{OL2}	P70 to P87	V_{CC} = 4.5 V, I_{OL2} = 30.0 mA	—	—	0.5	V	

■ Example of Oscillation circuit



11.4.2 Reset and Hardware Standby Input

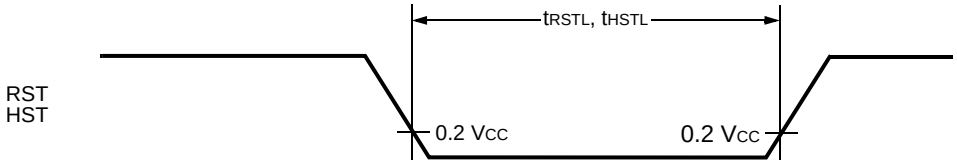
(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

Parameter	Symbol	Pin name	Value		Unit	Remarks
			Min	Max		
Reset input time	t_{RSTL}	$\overline{RST}$	16 t_{CP}*1	—	ns	Under normal operation
			Oscillation time of oscillator*2 + 16 t_{CP}*1	—	ms	In stop mode
Hardware standby input time	t_{HSTL}	$\overline{HST}$	16 t_{CP}*1	—	ns	Under normal operation
			Oscillation time of oscillator*2 + 16 t_{CP}*1	—	ms	In stop mode

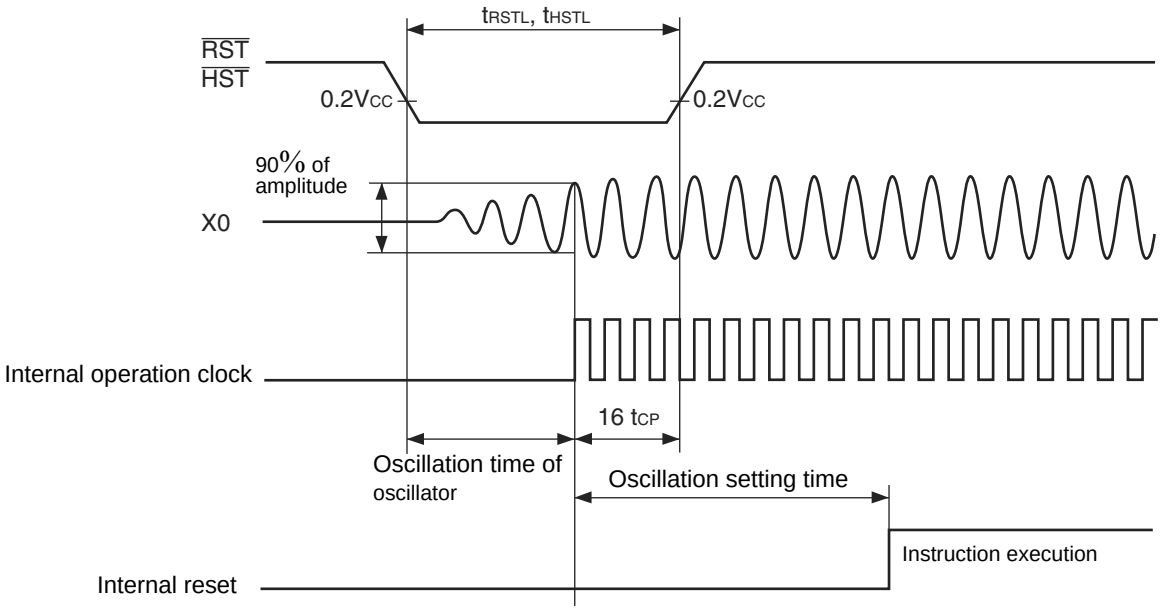
*1: "t_{cp}" represents one cycle time of the machine clock.
No reset can fully initialize the Flash Memory if it is performing the automatic algorithm.

*2: Oscillation time of oscillator is time that the amplitude reached the 90%.
In the crystal oscillator, the oscillation time is between several ms to tens of ms. In ceramic oscillator, the oscillation time is between hundreds of μs to several ms. In the external clock, the oscillation time is 0 ms.

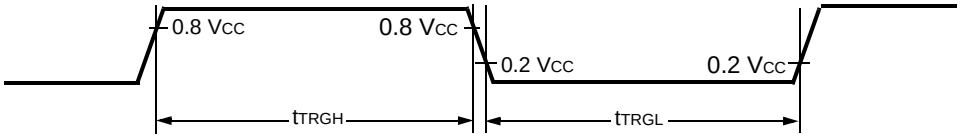
Under Normal Operation



In Stop Mode



- **Trigger Input Timing**



11.4.6 Slew Rate High Current Outputs (MB90598G, MB90F598G only)

(V_{CC} = 5.0 V±10 %, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Output Rise/Fall time	t_{R2} t_{F2}	Port P70 to P77, Port P80 to P87	—	15	40	150	ns	

- Slew Rate Output Timing

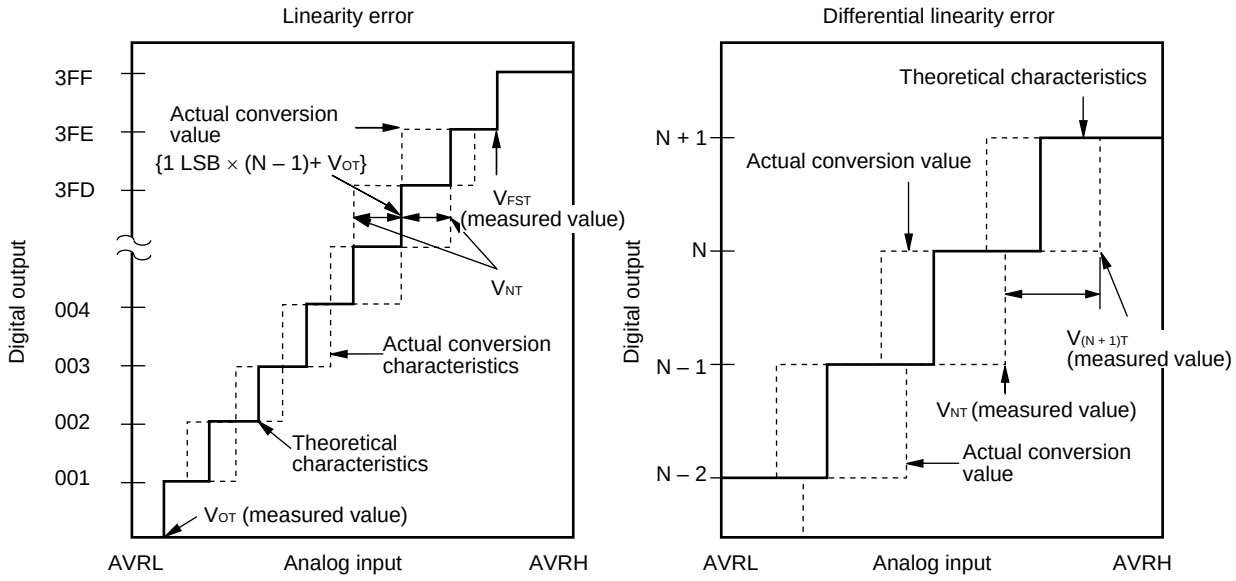
$V_H = V_{OL2} + 0.1 \times (V_{OH2} - V_{OL2})$
$V_L = V_{OL2} + 0.9 \times (V_{OH2} - V_{OL2})$

11.5 A/D Converter

(V_{CC} = AV_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V,3.0 V ≤ AVRH − AVRL, T_A = −40 °C to +85 °C)

Parameter	Sym-bol	Pin name	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	—	—	—		10	bit	
Conversion error	—	—	—	—	±5.0	LSB	
Nonlinearity error	—	—	—	—	±2.5	LSB	
Differential linearity error	—	—	—	—	±1.9	LSB	
Zero transition voltage	V_{OT}	AN0 to AN7	AVRL − 3.5 LSB	AVRL + 0.5 LSB	AVRL + 4.5 LSB	V	
Full scale transition voltage	V_{FST}	AN0 to AN7	AVRH − 6.5 LSB	AVRH − 1.5 LSB	AVRH + 1.5 LSB	V	
Conversion time	—	—	—	352t_{CP}	—	ns	
Sampling time	—	—	—	64t_{CP}	—	ns	
Analog port input current	I_{AIN}	AN0 to AN7	−10	—	10	µA	
Analog input voltage range	V_{AIN}	AN0 to AN7	AVRL	—	AVRH	V	

(Continued)



$$\text{Linearity error of digital output N} = \frac{V_{NT} - \{1\ \text{LSB} \times (N - 1) + V_{OT}\}}{1\ \text{LSB}}\ [\text{LSB}]$$

$$\text{Differential linearity error of digital N} = \frac{V_{(N+1)T} - V_{NT}}{1\ \text{LSB}} - 1\ \text{LSB}\ [\text{LSB}]$$

$$1\ \text{LSB} = \frac{V_{FST} - V_{OT}}{1022}\ [\text{V}]$$

V_{OT}: Voltage at transition of digital output from "000_H" to "001_H"
V_{FST}: Voltage at transition of digital output from "$3FE_H$" to "$3FF_H$"

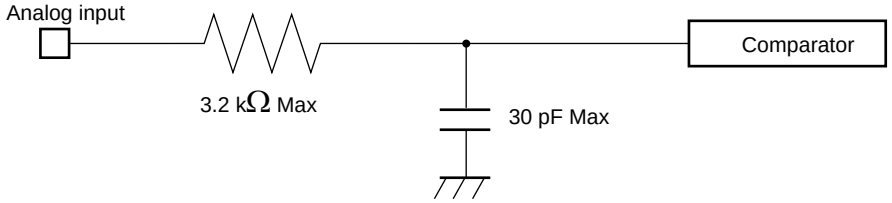
11.7 Notes on Using A/D Converter

Select the output impedance value for the external circuit of analog input according to the following conditions,:

- Output impedance values of the external circuit of 15 kΩ or lower are recommended.
- When capacitors are connected to external pins, the capacitance of several thousand times the internal capacitor value is recommended to minimized the effect of voltage distribution between the external capacitor and internal capacitor.

When the output impedance of the external circuit is too high, the sampling period for analog voltages may not be sufficient (sampling period = 4.00 μs @machine clock of 16 MHz).

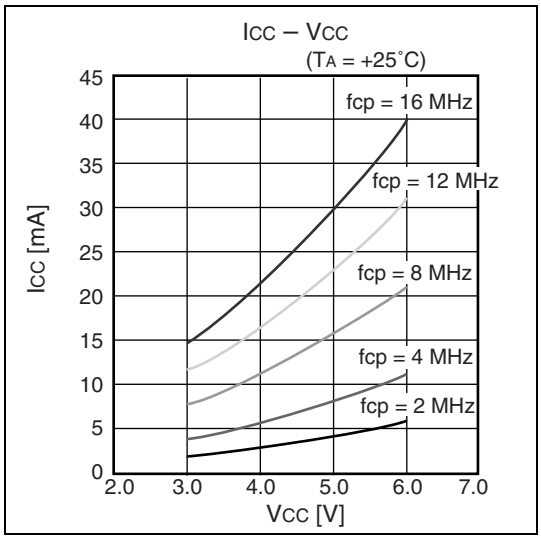
- **Equipment of analog input circuit model**

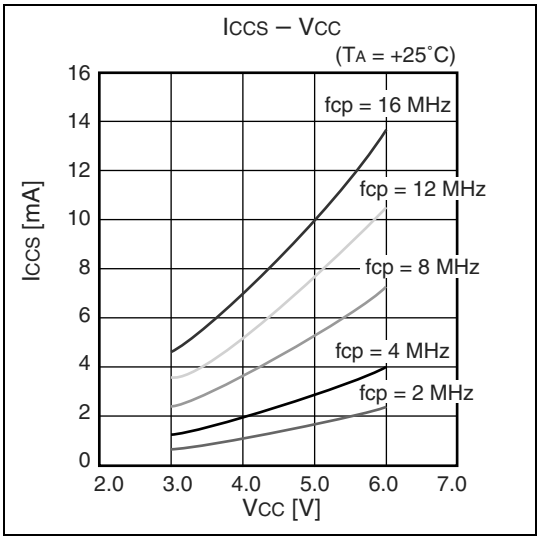


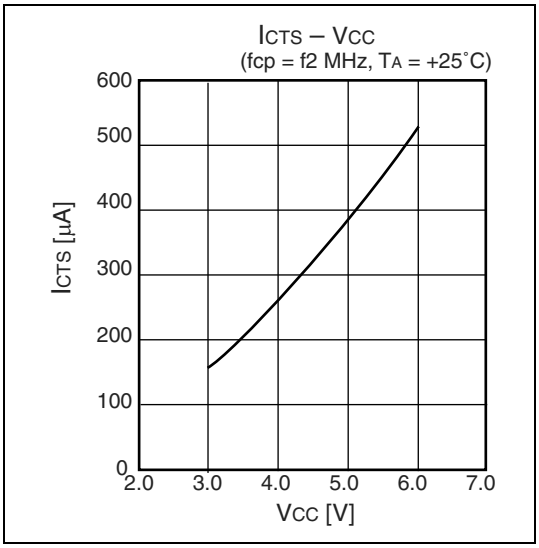
■ Error

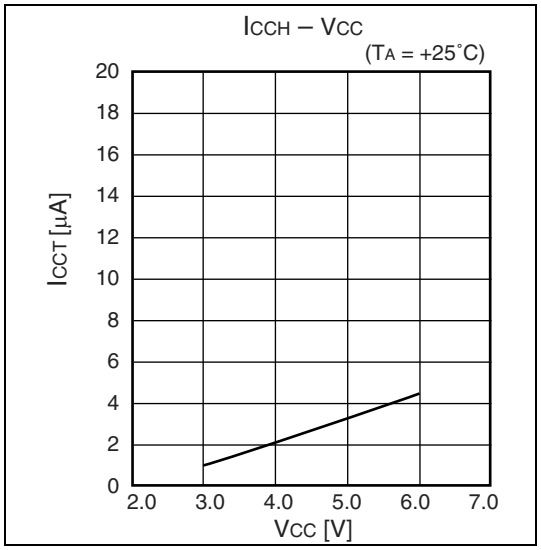
The smaller the | AVRH − AVRL |, the greater the error would become relatively.

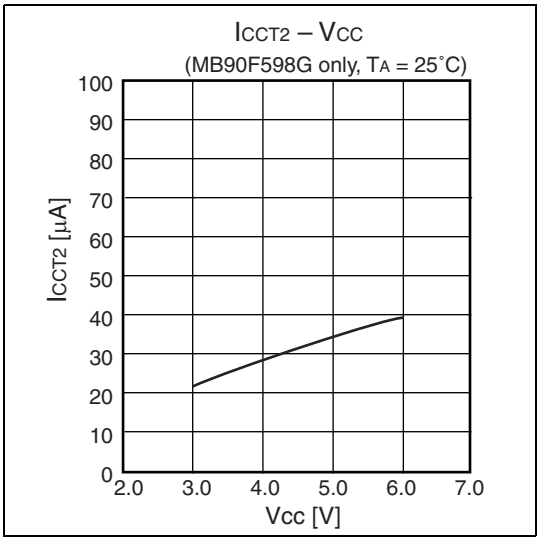
Supply Current







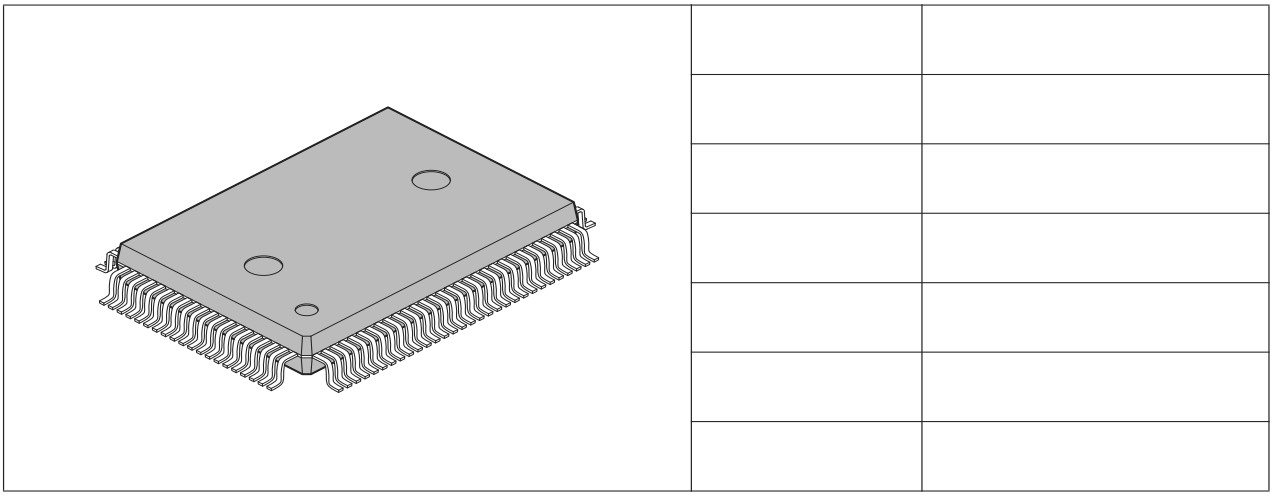


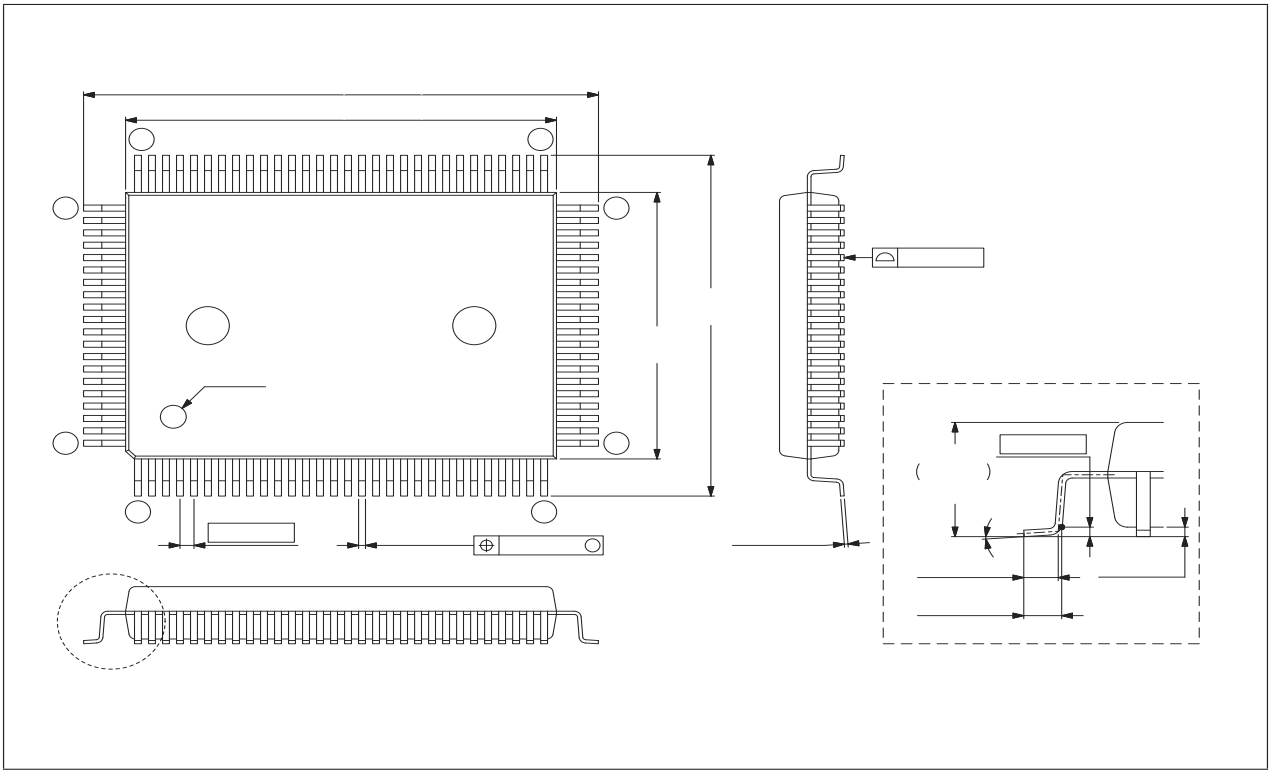


13. Ordering Information

Part number	Package	Remarks
MB90598GPF MB90F598GPF	100-pin Plastic QFP (FPT-100P-M06)	
MB90V595GCR	256-pin Ceramic PGA (PGA-256C-A01)	For evaluation

14. Package Dimensions





15. Major Changes

Spansion Publication Number: DS07-13705-7E

Section	Change Results
—	Deleted the old products, MB90598, MB90F598, and MB90V595.
—	Changed the series name; MB90595/595G series ? MB90595G series
—	Changed the following erroneous name. I/O timer → 16-bit Free-run Timer
PRODUCT LINEUP	One of Standby mode name is changed. Clock mode → Watch mode
I/O CIRCUIT TYPE	Changed Pull-down resistor value of circuit type H.
ELECTRICAL CHARACTERISTICS AC Characteristics	Add the “External clock input” and “Flash Read cycle time” in (1) Clock Timing
	Figure in (2) Reset and Hardware Standby Input RST/HST input level of “In Stop Mode” is changed. 0.6 V_{CC} 0.2 V_{CC}
ELECTRICAL CHARACTERISTICS 5. A/D Converter	Changed the items of “Zero transition voltage” and “Full scale transition voltage”.

NOTE: Please see “Document History” about later revised information.

Document History

Document Title: MB90598G/F598G/V595G F²MC-16LX MB90595G Series CMOS 16-bit Proprietary Microcontroller Document Number: 002-07700				
Revision	**ECN**	**Orig. of Change**	**Submission Date**	**Description of Change**
**	—	AKIH	09/26/2008	Migrated to Cypress and assigned document number 002-07700. No change to document contents or format.
*A	5537128	AKIH	11/30/2016	Updated to Cypress template